

Polyimide nanocomposites with functionalized SiO₂ nanoparticles: Enhanced processability, thermal and mechanical properties

Young-Jae Kim,^a Jong-Heon Kim,^b Shin-Woo Ha,^{a,c} Dongil Kwon,^{*b} Jin-Kyu Lee^{*a}

^aDepartment of Chemistry, Seoul National University, Seoul 151-747, Korea

^bDepartment of Materials Science and Engineering, Seoul National University, Seoul 151-744, Korea

^cPresent address: Department of Medicine, Emory University, Atlanta, GA 30322, USA

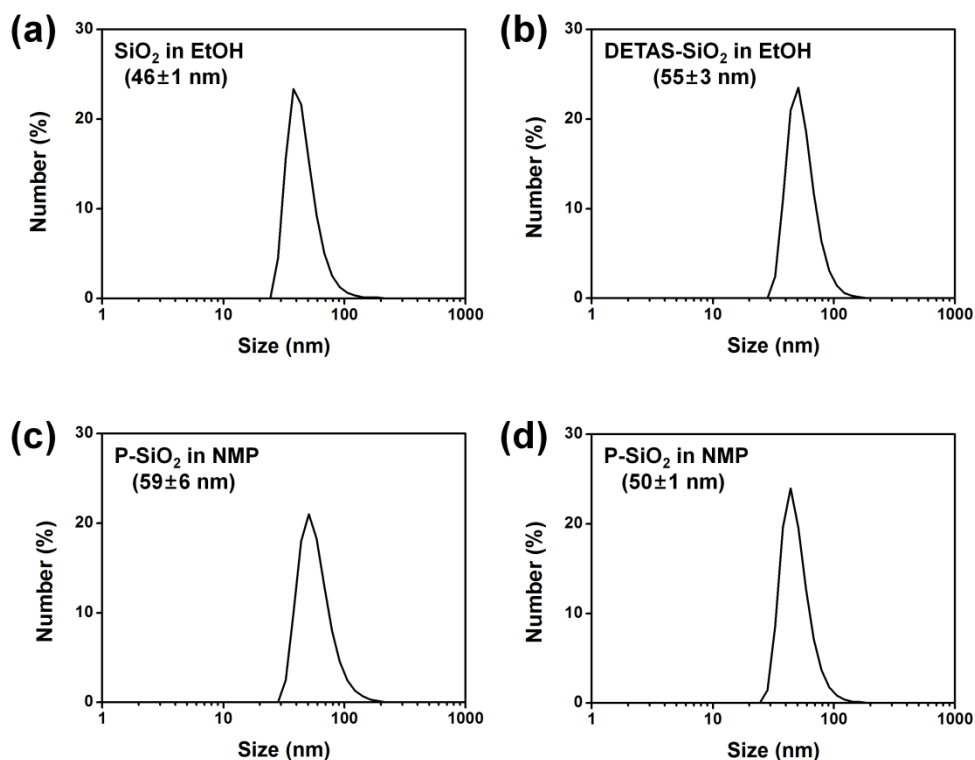


Figure. S1 Size distributions of (a) SiO₂ in EtOH, (b) DETAS-SiO₂ in EtOH, (c) as-prepared P-SiO₂ in NMP, and (d) P-SiO₂ in NMP after being stored for one year.

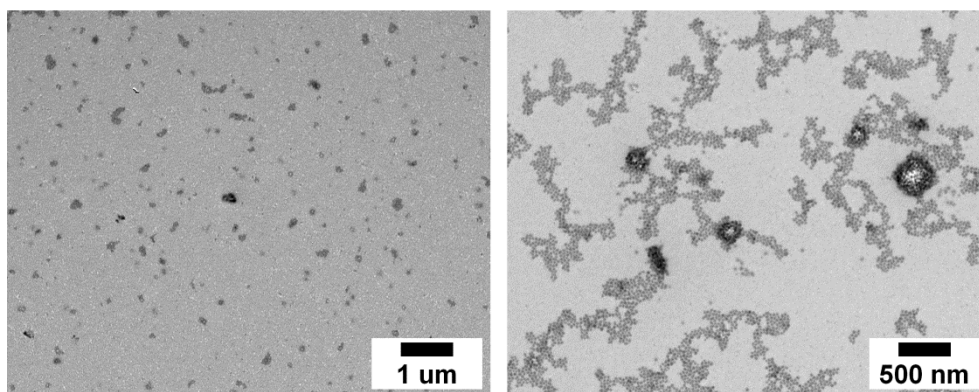


Figure. S2 TEM images of unmodified SiO₂-PI nanocomposites. The TEM images were obtained by spin-coating SiO₂-PAA solution onto a TEM grid, followed by thermal imidization.

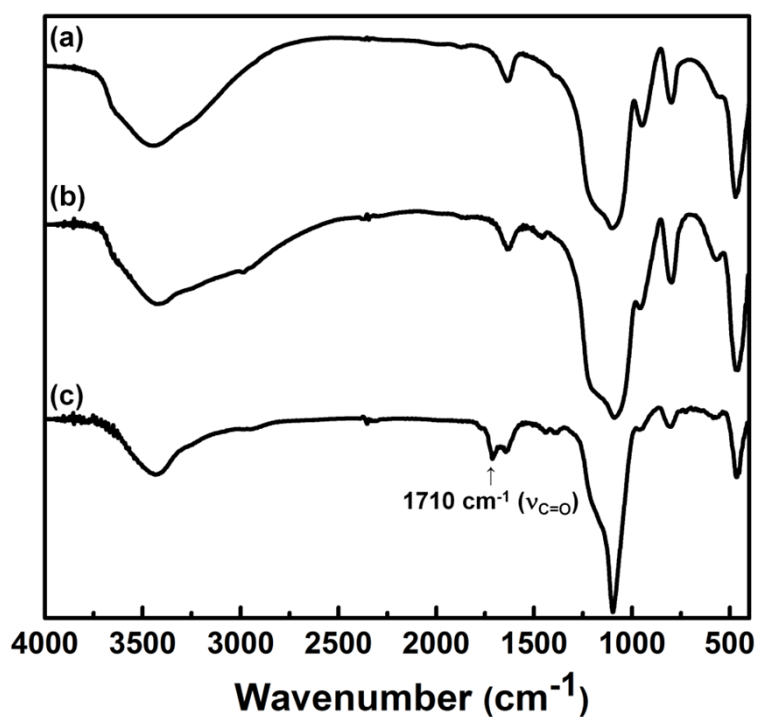


Figure. S3 FT-IR spectra of (a) unmodified silica nanoparticles, (b) DETAS-SiO₂, and (c) P-SiO₂.

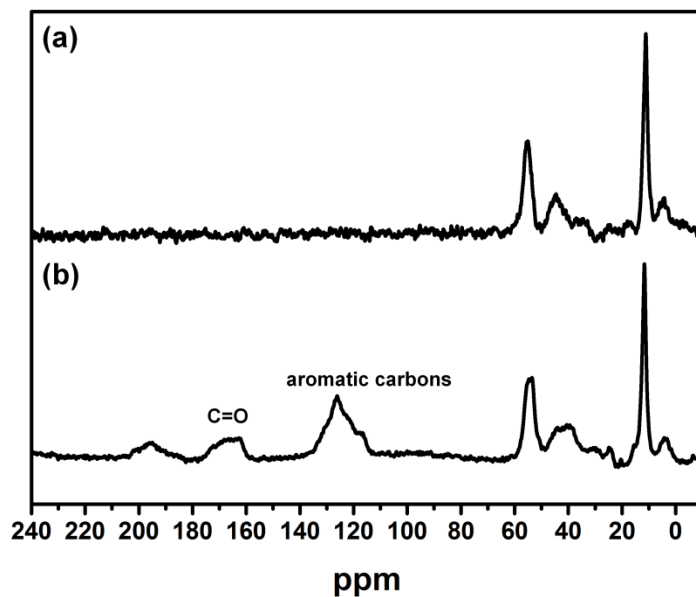


Figure. S4 Solid ^{13}C CP/MAS NMR spectra of (a) DETAS-SiO₂ and (b) P-SiO₂.

Table S1. Calculated molar ratio of organic groups on SiO₂ nanoparticles by TGA.

	Weight percent (wt%)	Molecular weight (g/mol)	Relative amount from 100 g sample (mol)	Mole percent of organic groups (mol%)
SiO ₂	87.4	60 (for fully condensed SiO ₂)	1.5	
DETAS on the DETAS-SiO ₂	5.6	265.43 (for DETAS)	2.1×10^{-2}	1.4
Phthalic anhydride on the P-SiO ₂	7	148.12 (for phthalic anhydride)	4.7×10^{-2}	3.1

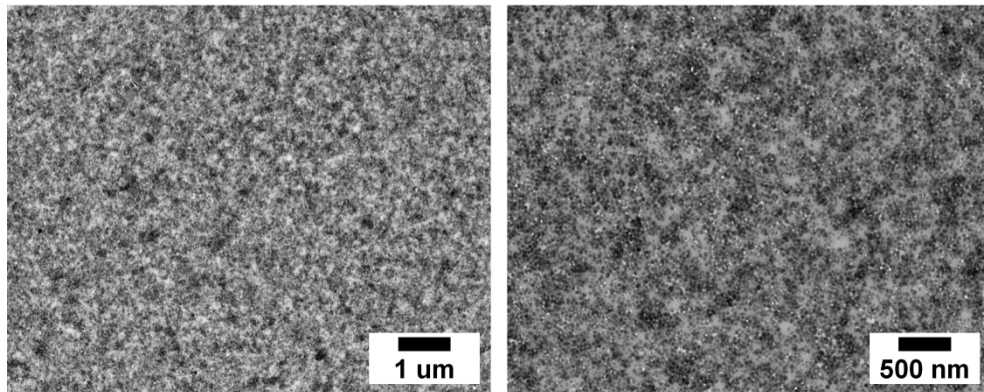


Figure. S5 TEM images of 40 wt% SiO₂-PI nanocomposites. The TEM images were obtained by spin-coating SiO₂-PAA solution onto a TEM grid, followed by thermal imidization.

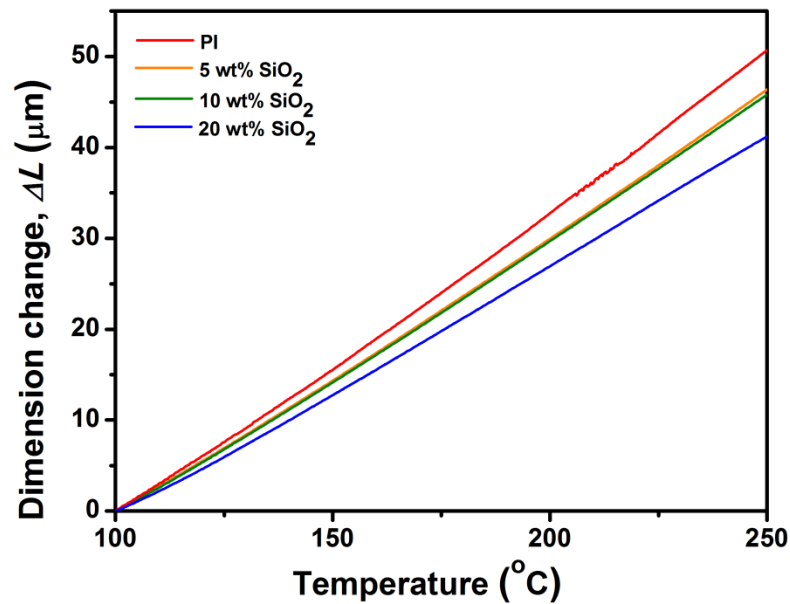


Figure. S6 Thermal expansion of neat PI film and SiO₂-PI nanocomposite films with various SiO₂ contents.

Calculation details

The mathematical equation¹ is described as follows:

$$\alpha_c = \alpha_f \phi_f + \alpha_m \phi_m$$

where the subscripts *c*, *m*, *f* represent nanocomposites, polymer, and filler phase, respectively. α and ϕ are coefficient of thermal expansion and the volume fraction of the constituents. The coefficient of thermal expansion for polyimide and SiO₂ are 33.9 and 0.55 (10⁻⁶/°C), respectively.

Table S2. The experimental and calculated value of coefficients of thermal expansion of polyimide and SiO₂-polyimide nanocomposites

wt. %	vol. %	Experimental value (10 ⁻⁶ /°C)	Calculated value (10 ⁻⁶ /°C)
Neat PI	-	33.9	-
5	2.2	30.8	33.1
10	4.6	30.6	32.2
20	9.8	27.8	30.2

1.H. S. Katz and J. V. Mileski, *Handbook Of Fillers For Plastics*, Springer, 1987, 49.